COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED, AND MAY NOT BE IN BILL OF MATERIALS
ASSEMBLY VARIANT: [No Variations]
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<table>
<thead>
<tr>
<th>PCB VIEWED FROM BOTTOM SIDE</th>
<th>PROJECT NAME = PMP7850 REV B</th>
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<tbody>
<tr>
<td>LAYER NAME =</td>
<td>ARTWORK 088 = 880XX7850-001 REV B</td>
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PLOT NAME = Bottom Assembly Drawing

GENERATED : 4/10/2015 5:40:19 PM
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